

ABSTRACT OF THE DISCLOSURE

A mold for producing a silicon ingot having a layered structure comprising an inner silica layer containing at least one layer in which a fused silica powder with a particle size of 100  $\mu\text{m}$  or less and a fine fused silica sand with a particle size of 100-300  $\mu\text{m}$  is bonded with a silica binder, and an outer silica layer containing at least one layer in which a fused silica powder with a particle size of 100  $\mu\text{m}$  or less and a coarse fused silica sand with a particle size of 500-1500  $\mu\text{m}$  is bonded with a silica binder.

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